

FORTRON® 1131L4

Polyphenylene sulfide

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Product information			
Resin Identification	PPS-GF30		ISO 1043
Part Marking Code	>PPS-GF30<		ISO 11469
Rheological properties			
Moulding shrinkage range, parallel	0.3 - 0.7	%	ISO 294-4, 2577
Moulding shrinkage range, normal	0.5 - 0.8	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	12200	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	165	MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	1.9	%	ISO 527-1/-2
Flexural modulus	12000		ISO 178
Flexural strength		MPa	ISO 178
Charpy impact strength, 23°C		kJ/m²	ISO 179/1eU
Charpy impact strength, -30 °C		kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C		kJ/m²	ISO 179/1eA
Charpy notched impact strength, -30 °C		kJ/m ²	ISO 179/1eA
Izod notched impact strength, 23°C		kJ/m² kJ/m²	ISO 180/1A
Izod notched impact strength, -30°C Izod impact strength, 23°C		kJ/m ²	ISO 180/1A ISO 180/1U
Hardness, Rockwell, M-scale	100	NO/III	ISO 2039-2
Poisson's ratio	0.33 ^[C]		100 2003 2
[C]: Calculated	0.00		
Thermal properties			
Thermal properties			
Melting temperature, 10°C/min	280		ISO 11357-1/-3
Glass transition temperature, 10°C/min		°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	265		ISO 75-1/-2
Temperature of deflection under load, 8 MPa	205		ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	29	E-6/K	ISO 11359-1/-2
Coefficient of linear thermal expansion (CLTE),	62	E-6/K	ISO 11359-1/-2
normal	OL.	L O/IX	100 11000 1/ 2
Flammability			
Burning Behav. at 1.5mm nom. thickn.	V-0	class	IEC 60695-11-10
Thickness tested		mm	IEC 60695-11-10
Burning Behav. at thickness h		class	IEC 60695-11-10
Thickness tested	0.38		IEC 60695-11-10
Electrical properties			
Volume resistivity	>1E13	Ohm.m	IEC 62631-3-1
Surface resistivity	>1E15		IEC 62631-3-2
Arc Resistance	124	S	UL 746B

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Physical/Other properties

Water absorption, 2mm	0.02 %	Sim. to ISO 62
Water absorption, Immersion 24h	0.03 %	Sim. to ISO 62
Density	1400 kg/m ³	ISO 1183

Injection

Drying Recommended	yes	
Drying Temperature	100	°C
Drying Time, Dehumidified Dryer	2 - 4	h
Processing Moisture Content	≤0.02	%
Melt Temperature Optimum	330	°C
Min. melt temperature	310	°C
Max. melt temperature	340	°C
Screw tangential speed	0.2 - 0.3	m/s
Mold Temperature Optimum	150	°C
Min. mould temperature	140	°C
Max. mould temperature	160	°C
Hold pressure range	30 - 70	MPa
Back pressure	3	MPa

Characteristics

Processing Injection Moulding

Delivery form Pellets

Additives Release agent

Special characteristics Flame retardant, Heat stabilised or stable to heat

Additional information

Processing Notes

Pre-Drying

FORTRON should in principle be predried. Because of the necessary low maximum residual moisture content the use of dry air dryers is recommended. The dew point should be =< - 30° C. The time between drying and processing should be as short as possible.

The pre-drying conditions can influence the flow (melt viscosity) of the material significantly. The drying temperature can be subject of optimization for flow of the material depending on the injection molding process and the tool- or part design.

Storage

For subsequent storage the material should be stored dry in the dryer until processed (<= 60 h).

Processing Notes

The higher drying conditions result in higher melt viscosity.

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